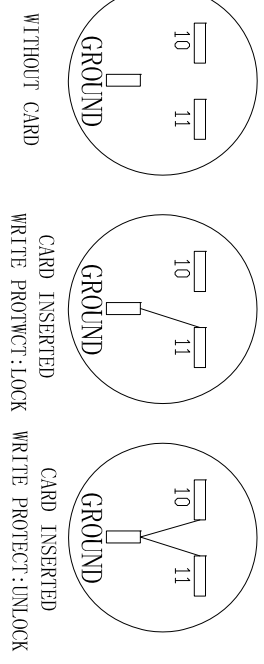


铁壳: TH12-SD11-275A

11--WRITE PROTECT PIN
 10--CARD DETECT PIN
 GROUND(SHELL) ---COMMON PIN

Pin No.	Name	Description
1#	CD/DAT3	Card detect/data I/O
2#	CMD	Command
3#	VSS1	Ground
4#	VDD	Power
5#	CLK	Clock
6#	VSS2	Ground
7#	DAT0	Data I/O
8#	DAT1	Data I/O
9#	DAT2	Data I/O

- NOTES:
1. MATERIAL
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC.
 CONTACT: COPPER ALLOY
 SHELL: COPPER ALLOY
 2. PLATING
 CONTACT AREA: GOLD PLATED OVER Ni
 SOLDER TAIL: 30u"MIN Sn PLATED OVER Ni
 SPEC SEE ORDERING INFORMATION
 3. RATING
 CURRENT RATING: 0.5A
 VOLTAGE RATING: 250VRMS
 OPERATING TEMPERATURE: -25°C ~ 90°C
 4. SPECIFICATION
 CONTACT RESISTANCE: 40 MΩ TYPICAL
 DIELECTRIC WITHSTANDING VOLTAGE: 500VAC Megohms
 INSULATION RESISTANCE: 100 Megohms
 INSERTION FORCE: 40N MAX
 SEPARATION FORCE: 2N MIN



鉾創科技有限公司 TRONTEK TECHNOLOGY CO., LTD.		PART NAME: SD NO PUSH 長卡座	
TOLERANCE: XX ±0.30 XXX ±0.25 XXXX ±0.15 X: ±Z XX' ±0.5'	DRAWN BY: SANDY	DATE: 2014-3-15	CHECKED BY: DAVTD
UNITS: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: FRANK	DATE: 2014-3-15	MOLD NO.: TH12-SD11-275
			DRAW NO.: 10F1
			SHEET NO.: 10F1